

**Gate resistor installed
Dual N-channel MOSFET**

KFC4A21300L Datasheet

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1. GENERAL DESCRIPTION

Gate resistor installed Dual N-channel MOSFET
For lithium-ion secondary battery protection circuits

2. FEATURES

- Source-source ON Resistance: $R_{SS(on)}$ typ. = 80 m Ω ($V_{GS} = 3.8$ V)
- CSP (Chip Size Package)
- RoHS compliant (EU RoHS / MSL: Level 1)

3. MARKING SYMBOL: 4D

4. PACKAGING

Embossed type (Thermo-compression sealing): 16,000 pcs / reel (standard)

5. ABSOLUTE MAXIMUM RATINGS $T_a = 25^\circ\text{C}$

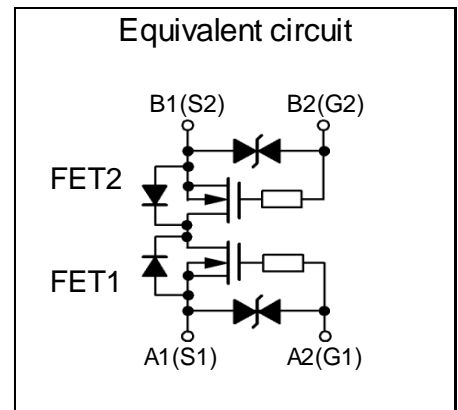
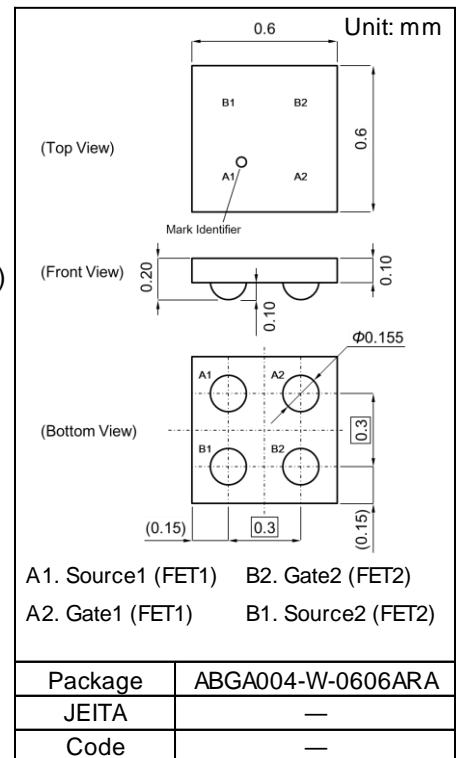
Parameter	Symbol	Rating	Unit
Source-source Voltage	VSS	12	V
Gate-source Voltage	VGS	± 8	V
Source Current (DC) ^{*1}	IS	1.5	A
Source Current (Pulsed) ^{*2}	ISp	15	A
Total Power Dissipation ^{*1}	PD	0.32	W
Channel Temperature	Tch	150	$^\circ\text{C}$
Storage Temperature Range	Tstg	-55 to +150	$^\circ\text{C}$

6. THERMAL CHARACTERISTICS $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Thermal Resistance (ch-a)	Rth ^{*1}	390	$^\circ\text{C} / \text{W}$

Note ^{*1} Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm),
using the recommended pad size (36 μm Copper).

^{*2} $t = 10 \mu\text{s}$, Duty Cycle $\leq 1\%$



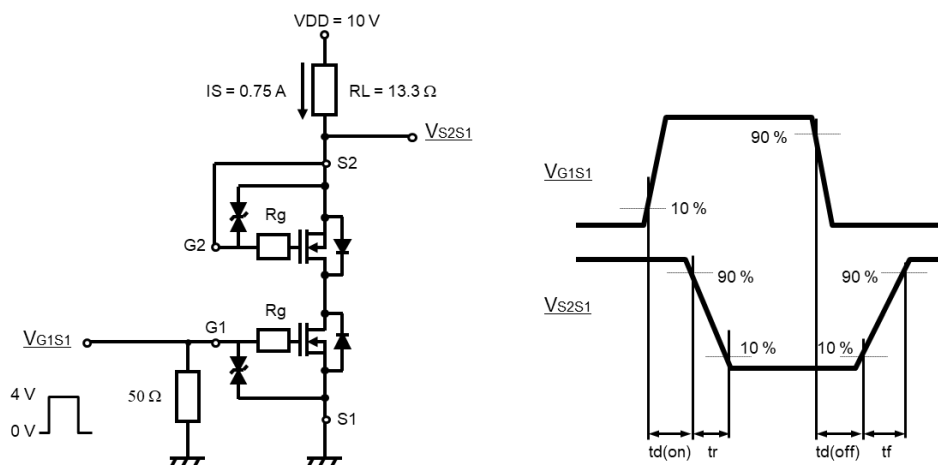
7. ELECTRICAL CHARACTERISTICS $T_a = 25\text{ }^{\circ}\text{C} \pm 3\text{ }^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Source-source Breakdown Voltage	VSSS	$I_S = 1\text{ mA}$, $V_{GS} = 0\text{ V}$	12			V
Zero Gate Voltage Source Current	ISSS	$V_{SS} = 12\text{ V}$, $V_{GS} = 0\text{ V}$			1.0	μA
Gate-Source Leakage Current	IGSS1	$V_{GS} = \pm 8\text{ V}$, $V_{SS} = 0\text{ V}$			± 10	μA
	IGSS2	$V_{GS} = \pm 5\text{ V}$, $V_{SS} = 0\text{ V}$			± 1.0	
Gate-source Threshold Voltage	V_{th}	$I_S = 0.03\text{ mA}$, $V_{SS} = 10\text{ V}$	0.35	0.90	1.40	V
Source-source On-state Resistance	RSS(on)1	$I_S = 0.75\text{ A}$, $V_{GS} = 4.5\text{ V}$	55	70	95	m Ω
	RSS(on)2	$I_S = 0.75\text{ A}$, $V_{GS} = 3.8\text{ V}$	60	80	110	
	RSS(on)3	$I_S = 0.75\text{ A}$, $V_{GS} = 3.1\text{ V}$	65	90	150	
	RSS(on)4	$I_S = 0.75\text{ A}$, $V_{GS} = 2.5\text{ V}$	70	115	225	
Body Diode Forward Voltage	$V_{F(s-s)}$	$I_F = 0.75\text{ A}$, $V_{GS} = 0\text{ V}$		0.6	1.2	V
Input Capacitance ^{*1}	Ciss	$V_{SS} = 10\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ kHz}$		115		pF
Output Capacitance ^{*1}	Coss			25		
Reverse Transfer Capacitance ^{*1}	Crss			18		
Turn-on delay Time ^{*1,*2}	$t_{d(on)}$	$V_{DD} = 10\text{ V}$, $V_{GS} = 0\text{ to }4\text{ V}$ $I_S = 0.75\text{ A}$		0.10		μs
Rise Time ^{*1,*2}	t_r			0.20		
Turn-off delay Time ^{*1,*2}	$t_{d(off)}$	$V_{DD} = 10\text{ V}$, $V_{GS} = 4\text{ to }0\text{ V}$ $I_S = 0.75\text{ A}$		0.27		μs
Fall Time ^{*1,*2}	t_f			0.22		
Total Gate Charge ^{*1}	Q_g	$V_{DD} = 10\text{ V}$		1.7		nC
Gate-source Charge ^{*1}	Q_{gs}	$V_{GS} = 0\text{ to }4\text{ V}$		0.5		
Gate-drain Charge ^{*1}	Q_{gd}	$I_S = 0.75\text{ A}$		0.45		

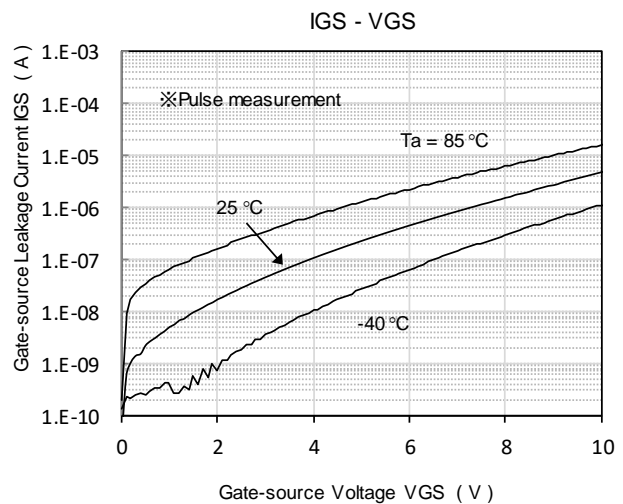
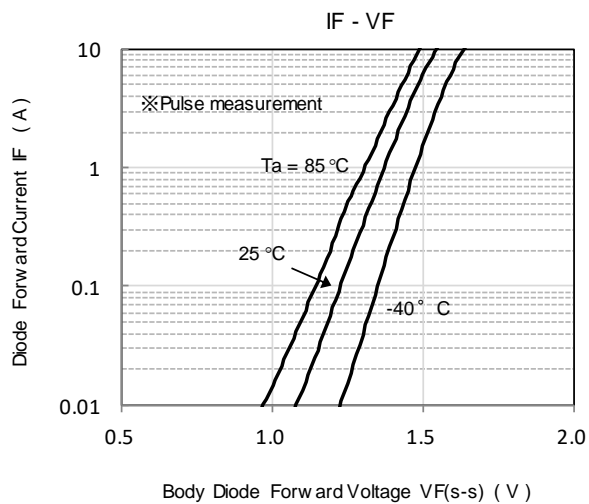
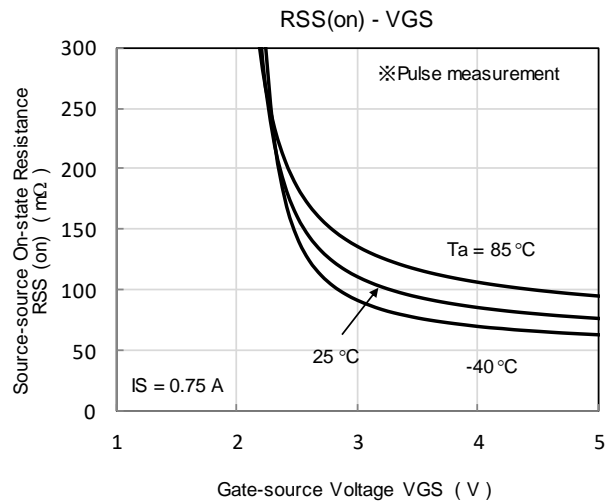
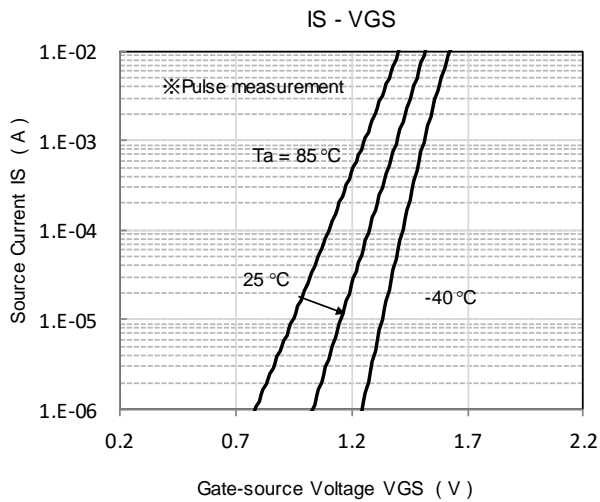
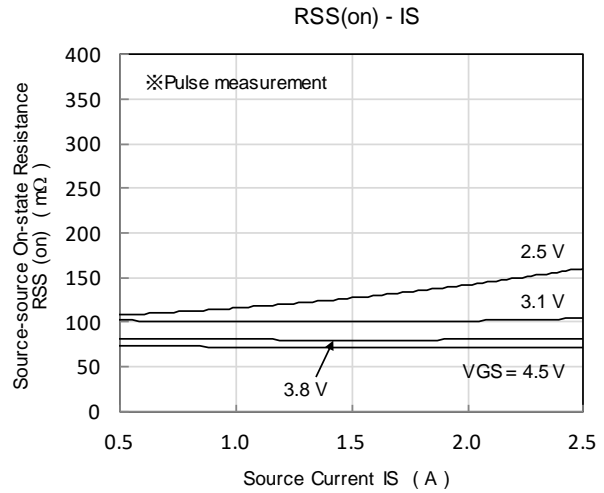
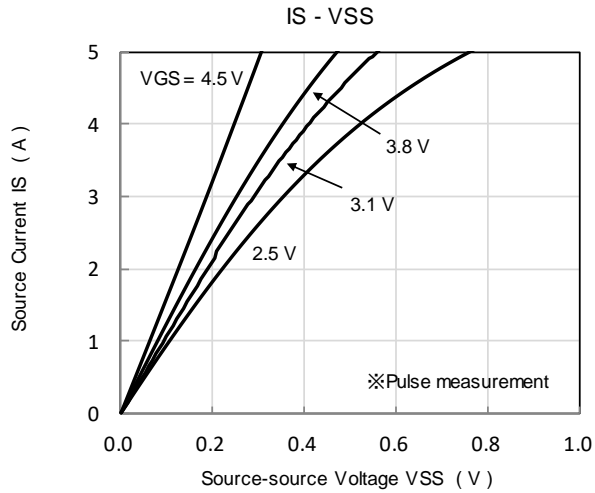
Note Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

*1 Guaranteed by design, not subject to production testing

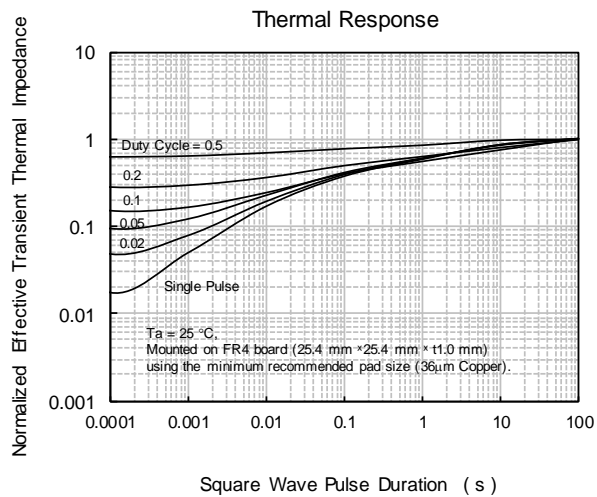
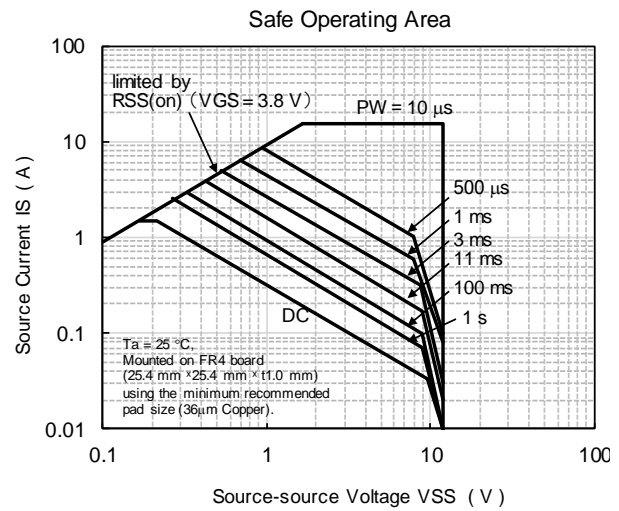
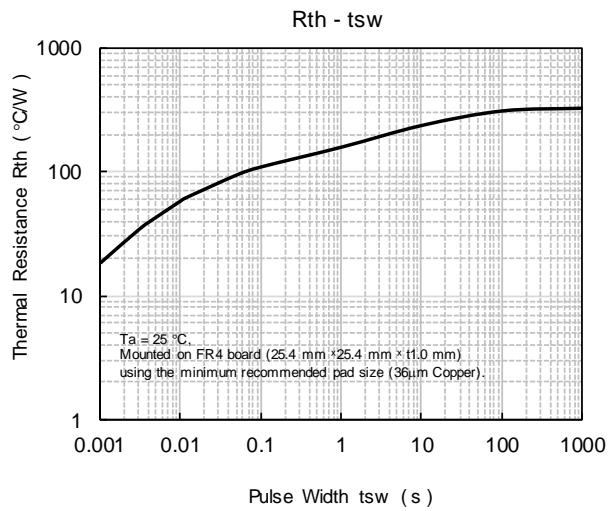
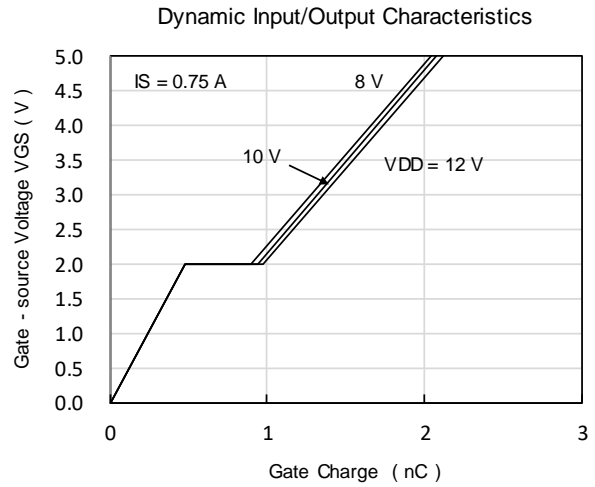
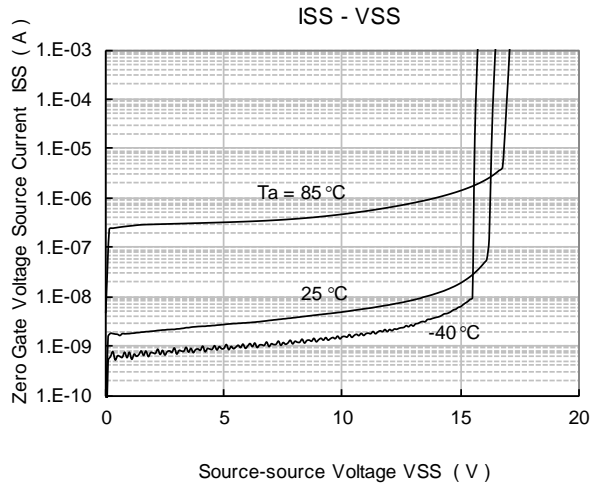
*2 Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time



8. TECHNICAL DATA (Reference)

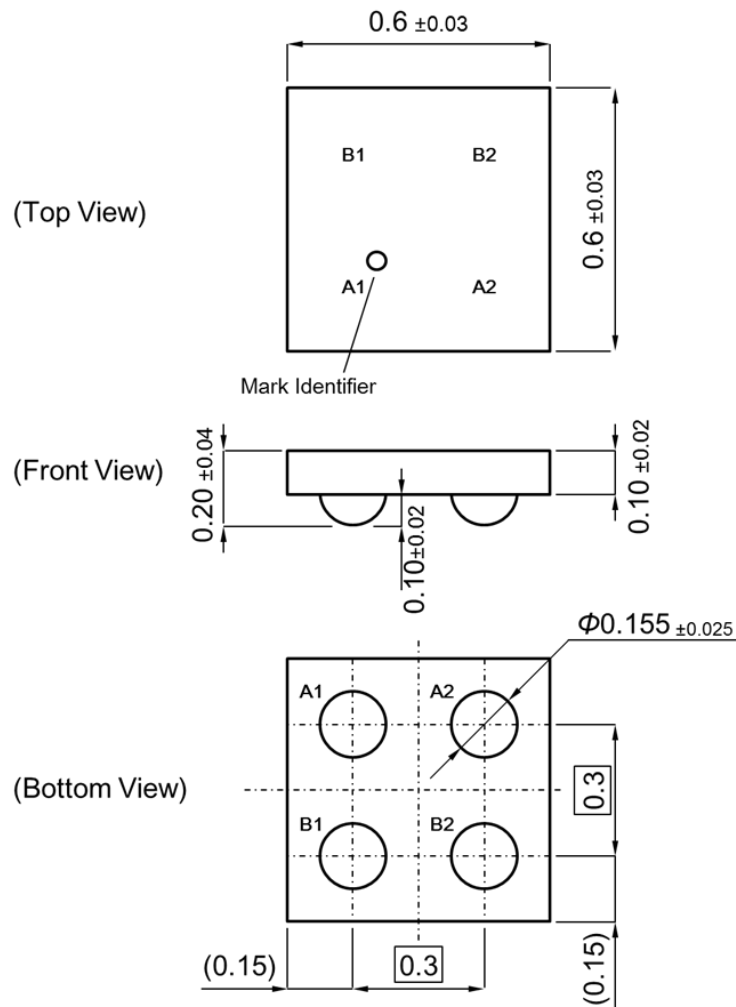


TECHNICAL DATA (Reference)



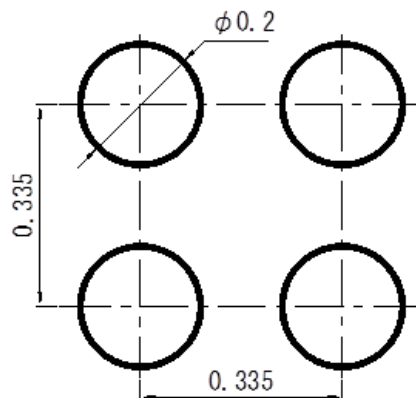
9. OUTLINE

Unit: mm



10. LAND PATTERN (Reference)

Unit: mm



Important notice:

Solder Mask Defined (SMD) pattern is strongly recommended for pad design.
Please check the information in the Nuvoton WL-CSP Application Notes about mounting process.

11. REVISION HISTORY

Date	Revision	Description
2021.02.03	1.00	1. Initially issued.
2021.08.31	1.01	1. Changed document name from Product Standards to Datasheet. 2. Added important notice in Land Pattern. 3. Added special attention and precautions notes.

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